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April 2001

**IGBT** 

# SGS6N60UFD

# **Ultra-Fast IGBT**

# **General Description**

Fairchild's UFD series of Insulated Gate Bipolar Transistors (IGBTs) provides low conduction and switching losses. The UFD series is designed for applications such as motor control and general inverters where high speed switching is a required feature..

## **Features**

- · High speed switching
- Low saturation voltage :  $V_{CE(sat)} = 2.1 \text{ V} @ I_C = 3A$
- · High input impedance
- CO-PAK, IGBT with FRD : t<sub>rr</sub> = 35ns (typ.)

# **Application**

AC & DC Motor controls, general purpose inverters, robotics, servo controls





# Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Description		SGS6N60UFD	Units
V <sub>CES</sub>	Collector-Emitter Voltage		600	V
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V
_	Collector Current	@ T <sub>C</sub> = 25°C	6	Α
I <sub>C</sub>	Collector Current	@ T <sub>C</sub> = 100°C	3	Α
I <sub>CM (1)</sub>	Pulsed Collector Current		25	Α
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100°C	4	Α
I <sub>FM</sub>	Diode Maximum Forward Current		25	Α
$P_{D}$	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	22	W
	Maximum Power Dissipation	@ T <sub>C</sub> = 100°C	9	W
T <sub>J</sub>	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
T <sub>L</sub>	Maximum Lead Temp. for soldering purposes, 1/8" from case for 5 seconds		300	°C

**Notes:**(1) Repetitive rating: Pulse width limited by max. junction temperature

# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
R <sub>θJC</sub> (IGBT)	Thermal Resistance, Junction-to-Case		5.5	°C/W
$R_{\theta JC}(DIODE)$	Thermal Resistance, Junction-to-Case		8.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Cha	racteristics					
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 250uA	600			V
ΔB <sub>VCES</sub> / ΔΤ <sub>J</sub>	Temperature Coeff. of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1mA		0.6		V/°C
I <sub>CES</sub>	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$			250	μΑ
$I_{GES}$	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$			± 100	nA
On Cha	racteristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 3mA$ , $V_{CE} = V_{GE}$	3.5	4.5	6.5	V
	Collector to Emitter	$I_{C} = 3A$ , $V_{GE} = 15V$		2.1	2.6	V
V <sub>CE(sat)</sub>	Saturation Voltage	$I_{C} = 6A, V_{GE} = 15V$		2.6		V
Dynami	c Characteristics					
C <sub>ies</sub>	Input Capacitance		T	220		pF
C <sub>oes</sub>	Output Capacitance	$V_{CE} = 30V, V_{GE} = 0V,$		22		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		7		pF
vvii(:TIII	nd Characteristics					
	ng Characteristics  Turn-On Delay Time			15		ns
t <sub>d(on)</sub>	Turn-On Delay Time			15 25		ns
t <sub>d(on)</sub>	Turn-On Delay Time Rise Time	Voc = 300 V to = 3A		25		ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-On Delay Time	$V_{CC} = 300 \text{ V}, I_{C} = 3A,$ $R_{C} = 80\Omega, V_{CE} = 15V.$				
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$R_G = 80\Omega, V_{GE} = 15V,$		25 60 70	130	ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $t_{on}$	Turn-On Delay Time Rise Time Turn-Off Delay Time			25 60	130 150	ns ns
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $E_{on}$	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss	$R_G = 80\Omega, V_{GE} = 15V,$	  	25 60 70 57	130 150	ns ns ns μJ
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> E <sub>on</sub> E <sub>off</sub> E <sub>ts</sub>	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss	$R_G = 80\Omega, V_{GE} = 15V,$	  	25 60 70 57 25	130 150 	ns ns ns µJ µJ
td(on) tr tr td(off) tf Eon Eoff Ets td(on)	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss	$R_G = 80\Omega, V_{GE} = 15V,$	   	25 60 70 57 25 82	130 150   120	ns ns ns μJ μJ
td(on)  tr  tr  td(off)  tf  Eon  Eoff  Ets  td(on)	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time	$R_G = 80\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 25$ °C	    	25 60 70 57 25 82 22	130 150   120	ns ns ns µJ µJ ns
td(on) t <sub>r</sub> td(off) tf Eon Ets td(on) tr td(off)	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time	$R_G = 80\Omega, V_{GE} = 15V,$	     	25 60 70 57 25 82 22 32	130 150   120	ns ns ns Lμ μμ Lμ ns
td(on)  tr  td(off)  tf  Eon  Eoff  Ets  td(on)  tr	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time	$R_G = 80\Omega$ , $V_{GE} = 15V$ , Inductive Load, $T_C = 25^{\circ}C$ $V_{CC} = 300 \text{ V}$ , $I_C = 3A$ ,	      	25 60 70 57 25 82 22 32 80	130 150  120  200	ns ns ns μJ μJ ns ns
td(on)  tr  td(off)  tt  Eon  Ets  td(on)  tr  td(off)	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$\begin{aligned} R_G &= 80\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 25^{\circ}C \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ V, \ I_C = 3A, \\ R_G &= 80\Omega, \ V_{GE} = 15V, \end{aligned}$	       	25 60 70 57 25 82 22 32 80 122	130 150  120  200 300	ns ns ns μ μ μ μ γ ns ns ns
td(on) tr td(off) tf Eon Eoff tts td(on) tr td(on) tr td(off) tr td(off) tr td(off) tf Eon	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss	$\begin{aligned} R_G &= 80\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 25^{\circ}C \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ V, \ I_C = 3A, \\ R_G &= 80\Omega, \ V_{GE} = 15V, \end{aligned}$	        	25 60 70 57 25 82 22 32 80 122 65	130 150  120  200 300	ns ns ns μJ Lμ ns ns ns ns
td(on)  tr  td(off)  tt  Eon  Ets  td(on)  tr  td(off)  Ets  td(on)  tr  td(off)  tf  Eon  Eon	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- On Switching Loss	$\begin{aligned} R_G &= 80\Omega, \ V_{GE} = 15\text{V}, \\ &\text{Inductive Load, } T_C = 25^{\circ}\text{C} \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ \text{V}, \ I_C = 3\text{A}, \\ R_G &= 80\Omega, \ V_{GE} = 15\text{V}, \\ &\text{Inductive Load, } T_C = 125^{\circ}\text{C} \end{aligned}$	        	25 60 70 57 25 82 22 32 80 122 65 46	130 150  120  200 300	ns ns ns μ μ μ ns ns ns ns ns
td(on) tr td(off) tf Eon Ets td(on) tr td(off) Ets Cd(on) tr td(off) tr Edital	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- On Switching Loss Turn- Off Switching Loss Turn- Off Switching Loss Total Switching Loss	$\begin{aligned} R_G &= 80\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 25^{\circ}C \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ \text{V}, \ I_C = 3A, \\ R_G &= 80\Omega, \ V_{GE} = 15V, \\ &\text{Inductive Load, } T_C = 125^{\circ}C \end{aligned}$ $\begin{aligned} V_{CE} &= 300 \ \text{V}, \ I_C = 3A, \end{aligned}$	            	25 60 70 57 25 82 22 32 80 122 65 46	 130 150  120  200 300  170	ns ns ns sn Lu Lu sn sn sn sn cn Lu
## Total Control Contr	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-On Switching Loss Turn-Off Switching Loss Total Switching Loss Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn- On Switching Loss Turn- Off Switching Loss Turn- Off Switching Loss Turn- Off Switching Loss Total Switching Loss Total Gate Charge	$\begin{aligned} R_G &= 80\Omega, \ V_{GE} = 15\text{V}, \\ &\text{Inductive Load, } T_C = 25^{\circ}\text{C} \end{aligned}$ $\begin{aligned} V_{CC} &= 300 \ \text{V}, \ I_C = 3\text{A}, \\ R_G &= 80\Omega, \ V_{GE} = 15\text{V}, \\ &\text{Inductive Load, } T_C = 125^{\circ}\text{C} \end{aligned}$		25 60 70 57 25 82 22 32 80 122 65 46 111	 130 150  120  200 300  170 22	ns ns ns Lu Lu ns

# Electrical Characteristics of DIODE $T_{C} = 25^{\circ}\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condit	tions	Min.	Тур.	Max.	Units
V	Diode Forward Voltage	I <sub>F</sub> = 4A	$T_C = 25^{\circ}C$		1.4	1.7	V
$V_{FM}$	blode Forward Voltage	1F = 4A	T <sub>C</sub> = 100°C		1.3		] V
+	Diode Reverse Recovery Time		$T_C = 25^{\circ}C$		35	52	ns
t <sub>rr</sub>	blode neverse necovery fillie		T <sub>C</sub> = 100°C		53		115
1	Diode Peak Reverse Recovery	$I_F = 4A$ ,	$T_C = 25^{\circ}C$		3.5	5.0	Α
<sup>I</sup> rr	Current	$di/dt = 200A/\mu s$	T <sub>C</sub> = 100°C		4.5		Α
0	Q <sub>rr</sub> Diode Reverse Recovery Charge		$T_C = 25^{\circ}C$		60	135	nC
Q <sub>rr</sub>			T <sub>C</sub> = 100°C		120		10

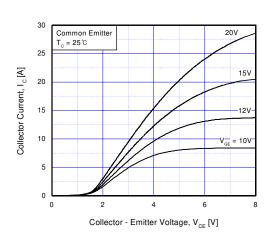


Fig 1. Typical Output Chacracteristics

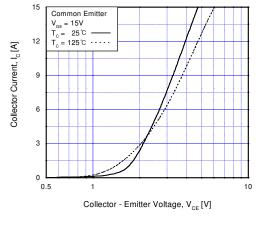


Fig 2. Typical Saturation Voltage Characteristics

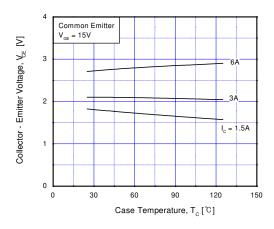


Fig 3. Saturation Voltage vs. Case Temperature at Variant Current Level

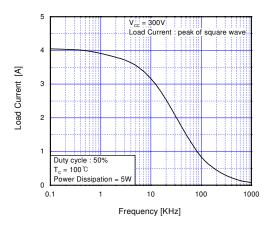


Fig 4. Load Current vs. Frequency

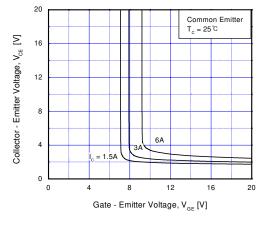


Fig 5. Saturation Voltage vs.  $V_{\text{GE}}$ 

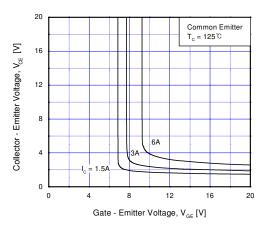
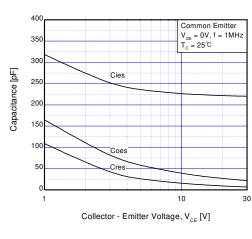


Fig 6. Saturation Voltage vs.  $V_{\rm GE}$ 

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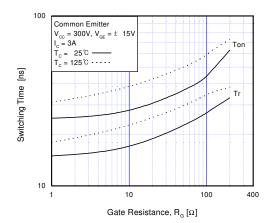
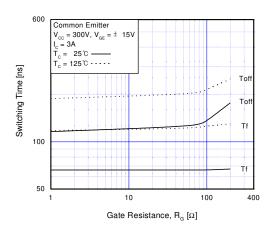


Fig 7. Capacitance Characteristics

Fig 8. Turn-On Characteristics vs.
Gate Resistance



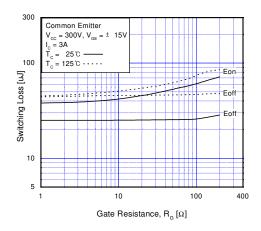
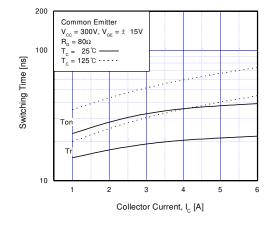


Fig 9. Turn-Off Characteristics vs.
Gate Resistance

Fig 10. Switching Loss vs. Gate Resistance



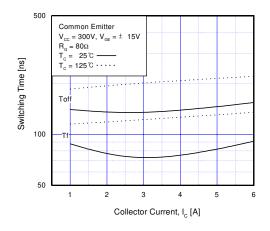
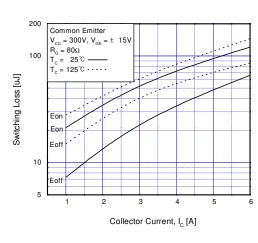


Fig 11. Turn-On Characteristics vs. Collector Current

Fig 12. Turn-Off Characteristics vs. Collector Current



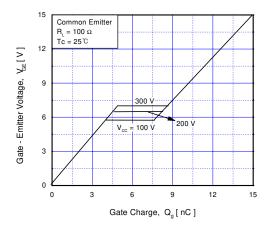
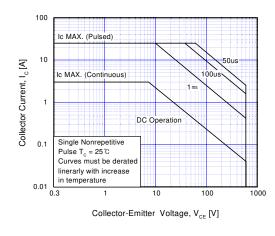


Fig 13. Switching Loss vs. Collector Current

Fig 14. Gate Charge Characteristics



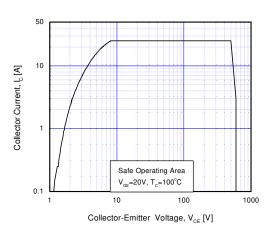


Fig 15. SOA Characteristics

Fig 16. Turn-Off SOA Characteristics

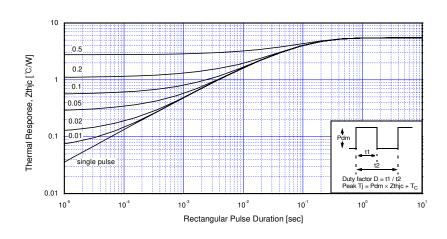
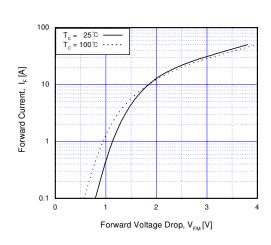


Fig 17. Transient Thermal Impedance of IGBT



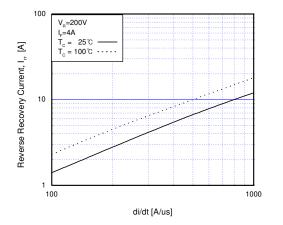
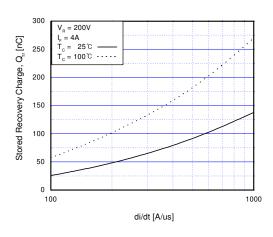


Fig 18. Forward Characteristics

Fig 19. Reverse Recovery Current



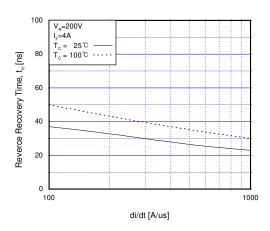
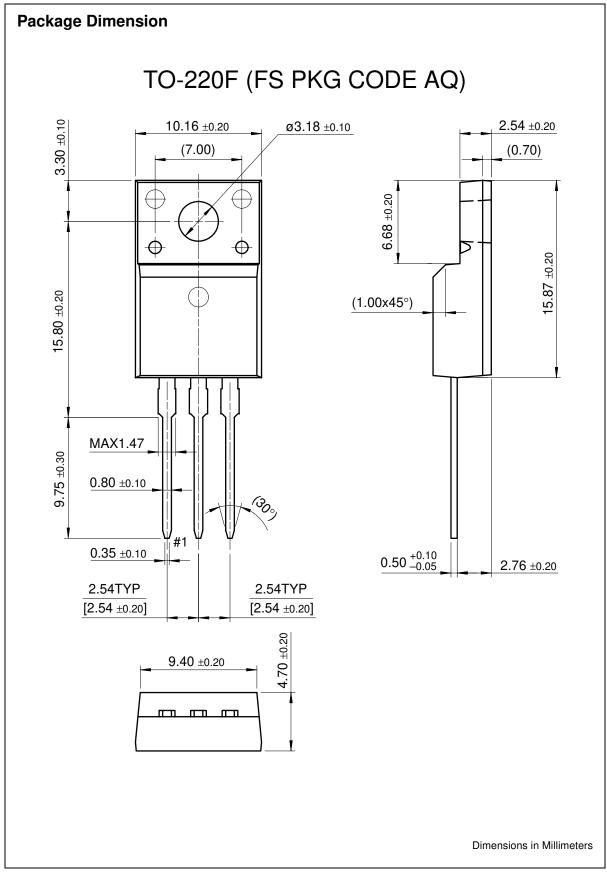


Fig 20. Stored Charge

Fig 21. Reverse Recovery Time



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